

SCT3120AW7 N-channel SiC power MOSFET

V _{DSS}	650V
R _{DS(on)} (Typ.)	120mΩ
I_{D}^{*1}	21A
P _D	100W

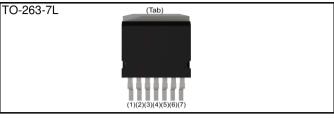
Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

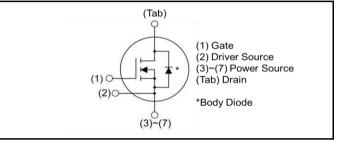
Application

- Solar inverters
- DC/DC converters
- · Switch mode power supplies
- Induction heating
- Motor drives

Outline



Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

	Packing	Embossed tape
	Reel size (mm)	330
Tuno	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT3120AW7

●Absolute maximum ratings (T_{vj} = 25°C unless otherwise specified)

Parameter		Value	Unit	
Drain - Source Voltage		650	V	
Continuous Drain current $T_c = 25^{\circ}C$		21	А	
$T_c = 100^{\circ}C$	۱ _D *۱	15	А	
Pulsed Drain current ($T_c = 25^{\circ}C$)		52	А	
Gate - Source voltage (DC)		-4 to +22	V	
Gate - Source surge voltage (t _{surge} < 300ns)		-4 to +26	V	
Recommended drive voltage		0 / +18	V	
Virtual Junction temperature		175	°C	
Range of storage temperature		-55 to +175	°C	
	T _c = 100°C		$\begin{tabular}{ c c c c c c } \hline V_{DSS} & 650 \\ \hline V_{DSS} & 650 \\ \hline I_{D}^{*1} & 21 \\ \hline T_{c} = 100^{\circ}\text{C} & I_{D}^{*1} & 15 \\ \hline & & & & & \\ \hline & & & & & \\ \hline & & & &$	

•Electrical characteristics ($T_{vj} = 25^{\circ}C$ unless otherwise specified)

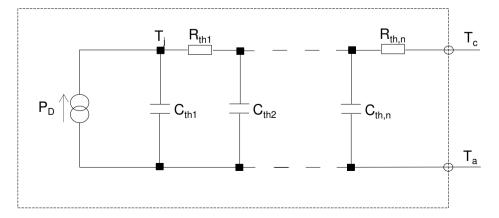
Deremeter	Symbol	Conditions	Values			Unit
Parameter	Symbol Conditions –		Min.	Тур.	Max.	Unit
		$V_{GS} = 0V, I_D = 1mA$				
Drain - Source breakdown voltage	$V_{(BR)DSS}$	$T_{vj} = 25^{\circ}C$	650	-	-	V
		T _{vj} = -55°C	650	-	-	
		$V_{GS} = 0V, V_{DS} = 650V$				
Zero Gate voltage Drain current	I _{DSS}	$T_{vj} = 25^{\circ}C$	-	1	10	μA
		T _{vj} = 150°C	-	2	-	
Gate - Source leakage current	I _{GSS+}	V_{GS} = +22V, V_{DS} = 0V	-	-	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = 10V, I_{D} = 3.33mA$	2.7	-	5.6	V
		$V_{GS} = 18V, I_{D} = 6.7A$				
Static Drain - Source on - state resistance	${\sf R}_{\sf DS(on)}$ *5	T _{vj} = 25°C	-	120	156	mΩ
		$T_{vj} = 150^{\circ}C$	-	172	-	
Gate input resistance	R _G	f = 1MHz, open drain	-	18	-	Ω

Thermal resistance

Parameter	Symbol	Values			Unit
		Min.	Тур.	Max.	Offic
Thermal resistance, junction - case ^{*6}	R _{thJC}	-	1.17	1.5	K/W

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	1.95×10 ⁻¹		C _{th1}	1.38×10 ⁻³	
R _{th2}	3.47×10 ⁻¹	K/W	C _{th2}	1.40×10 ⁻²	Ws/K
R _{th3}	5.60×10 ⁻¹		C _{th3}	8.68×10 ⁻³	





•Electrical characteristics (T_{vj} = 25°C unless otherwise specified)

Deremeter	Cumbal	Conditions	Values			Unit	
Parameter	Symbol	Symbol Conditions		Тур.	Max.	Unit	
Transconductance	g _{fs} *5	$V_{DS} = 10V, I_{D} = 6.7A$	-	2.7	-	S	
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	460	-		
Output capacitance	C_{oss}	$V_{DS} = 500V$	-	35	-	pF	
Reverse transfer capacitance	C_{rss}	f = 1MHz	-	16	-		
Effective output capacitance, energy related	$C_{o(er)}$	$V_{GS} = 0V$ $V_{DS} = 0V$ to 300V	-	70	-	pF	
Total Gate charge	Q_g^{*5}	$V_{DS} = 300V$ $I_{D} = 6.7A$	-	38	-		
Gate - Source charge	Q_{gs} *5	$V_{GS} = 18V$	-	10	-	nC	
Gate - Drain charge	Q_{gd} *5	See Fig. 1-1.	-	18	-		
Turn - on delay time	t _{d(on)} *5	$V_{DS} = 400V$ $I_{D} = 5.0A$	-	6	-		
Rise time	t _r *5	V _{GS} = 0V/+18V	-	14	-	20	
Turn - off delay time	t _{d(off)} *5	R _G = 0Ω, L = 750μH L _σ = 50nH, C _σ = 10pF	-	19	-	ns	
Fall time	t _f *5	See Fig. 2-1, 2-2, 2-3.	-	11	-		
Turn - on switching loss	E_{on} *5	E _{on} includes diode reverse recovery.	-	49	-	1	
Turn - off switching loss	${\sf E}_{\sf off}$ *5		-	4	-	μJ	

3/15



SCT3120AW7

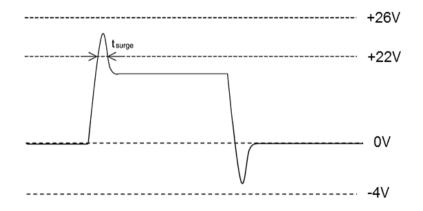
●Body diode electrical characteristics (Source-Drain) (T_{vi} = 25°C unless otherwise specified)

Parameter	Symbol	Conditions	Values			Unit	
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Body diode continuous, forward current	ا _S *1	T _c = 25°C	-	-	21	А	
Body diode direct current, pulsed	I _{SM} *2	T _c = 25 0	-	-	52	А	
Forward voltage	V_{SD} *5	$V_{GS} = 0V, I_{S} = 6.7A$	-	3.2	-	V	
Reverse recovery time	t _{rr} *5	$I_{\rm F} = 5.0 {\rm A}$ $V_{\rm B} = 400 {\rm V}$	-	11	-	ns	
Reverse recovery charge	Q _{rr} *5	di/dt = 2500A/µs	-	133	-	nC	
Peak reverse recovery current	I _{rrm} *5	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	11	-	А	

*1 Limited by maximum T_{vj} and for Max. R_{thJC} .

*2 PW \leq 10µs, Duty cycle \leq 1%

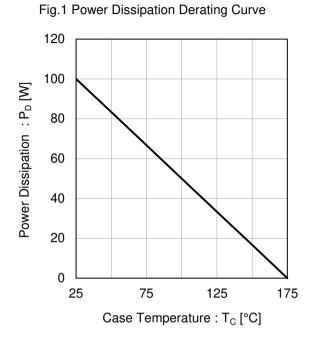
*3 Example of acceptable V_{GS} waveform



Please note especially when using driver source that $V_{\text{GSS_surge}}$ must be in the range of absolute maximum rating.

- *4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.
- *5 Pulsed
- *6 The case is bottom of leadframe underneath the chip. Practial value of Rth(j-c) is influenced by design of the user. Discribed value is only vaild at the specific conditions such as JESD51-14.





100 Operation in this area is limited by R_{DS(on)} Drain Current : I_D [A] 10 PW = 1µs' PW = 10µs' PW = 100µs PW = 1ms 1 PW = 10ms T_c = 25⁰C Single Pulse *Calculation(PW≤10µs) 0.1 0.1 100 1000 1 10 Drain - Source Voltage : V_{DS} [V]

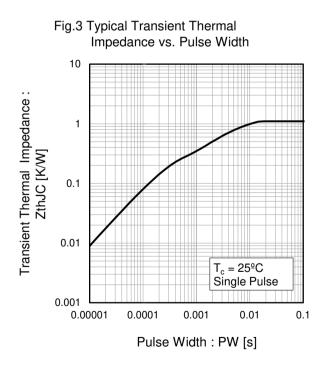
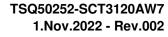


Fig.2 Maximum Safe Operating Area



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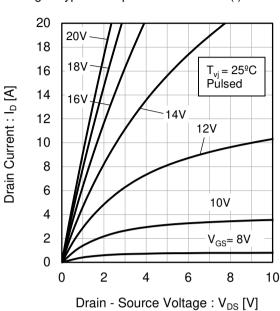


Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)

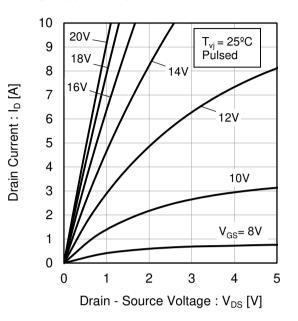
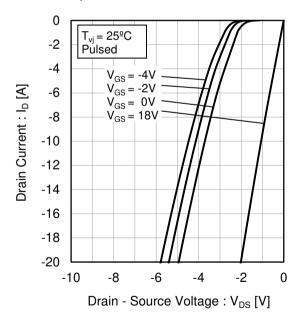


Fig.6 T_{vi} = 25°C 3rd Quadrant Characteristics





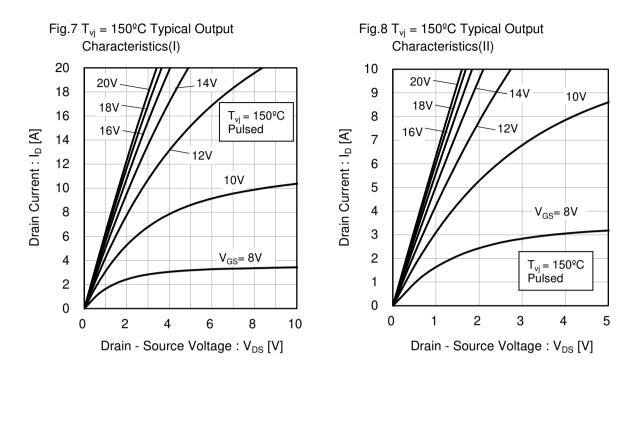


Fig.9 T_{vj} = 150°C 3rd Quadrant Characteristics

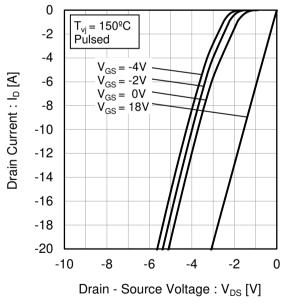
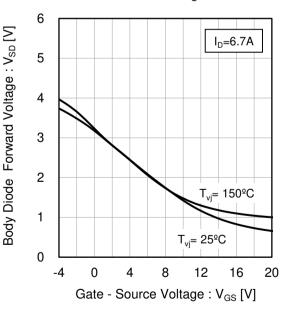


Fig.10 Body Diode Forward Voltage vs. Gate - Source Voltage



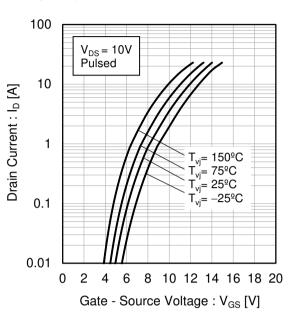


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)

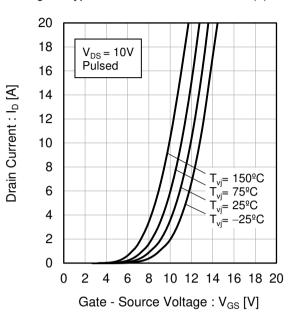
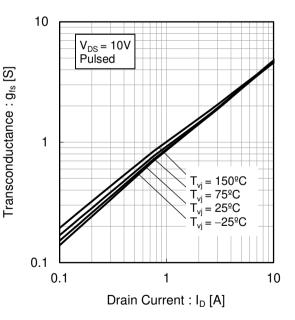
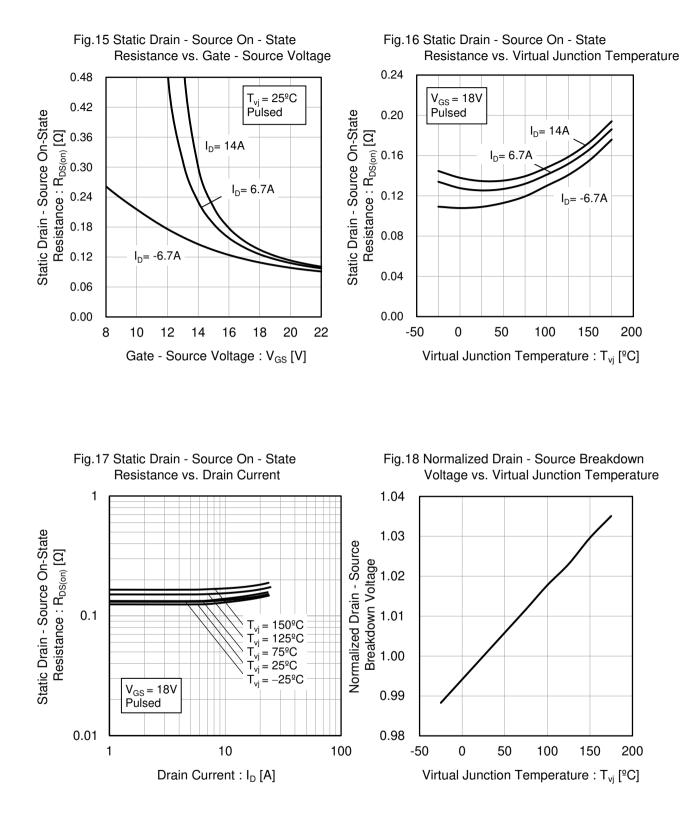


Fig.13 Gate Threshold Voltage vs. Virtual Junction Temperature 6 $V_{DS} = 10V$ $I_{D} = 3.33mA$ Gate Threshold Voltage : V GS(th) [V] 5 4 3 2 1 0 0 -50 50 100 150 200 Virtual Junction Temperature : T_{vj} [ºC]

Fig.14 Transconductance vs. Drain Current







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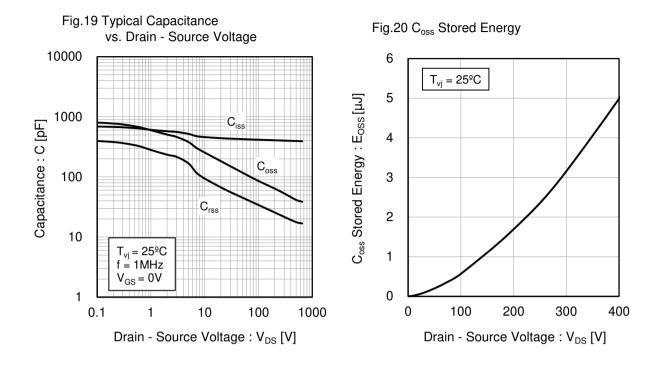
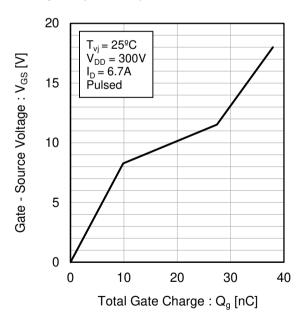
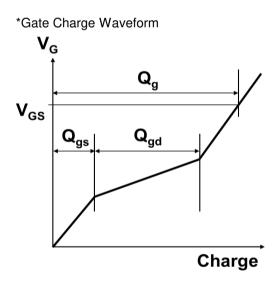
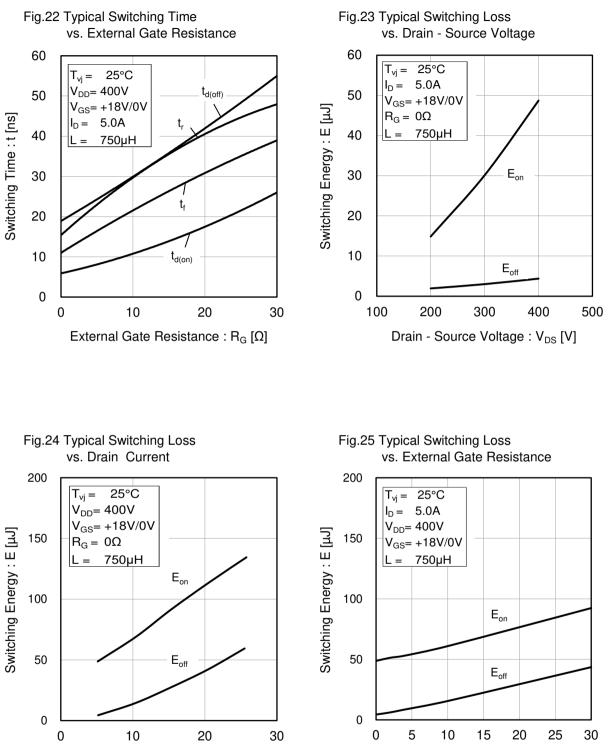


Fig.21 Dynamic Input Characteristics









External Gate Resistance : $R_G [\Omega]$

Drain Current : I_D [A]





Measurement circuits and waveforms



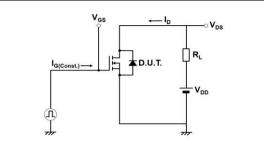


Fig.2-1 Switching Characteristics Measurement Circuit

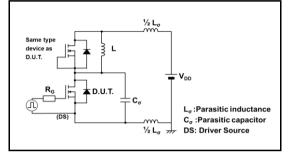


Fig.2-3 Waveforms for Switching Energy Loss

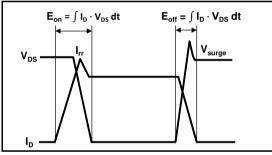
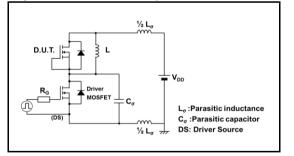


Fig.3-1 Reverse Recovery Time Measurement Circuit





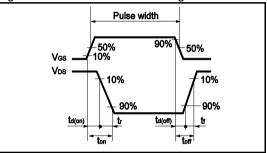
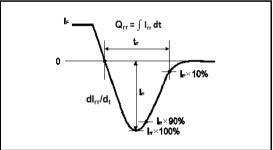
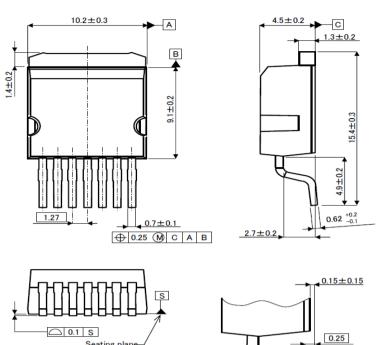


Fig.3-2 Reverse Recovery Waveform





• Package Dimensions



1

Gauge plane

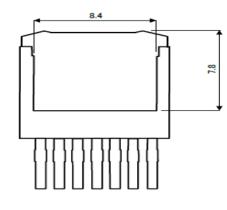
2.3±0.15

±4° 4°

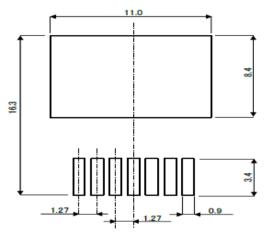
Seating plane







RECOMMENDED FOOTPRINT DIMENSIONS



Unit: mm





•Die Bonding Layout

 $\boldsymbol{\cdot}$ Front view of the packaging.

•Dimensions are design values.

·If the heat sink is to be installed, it should be in contact with the die bonding point.

Unit: mm





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